

Quiz 3: Lectures 8 and 9 EEE4084F 2015-04-16



[6 Total]

Instructions:

- Answer on a separate page.
- Make sure that your student number is on all your answer pages.
- There are 6 questions, each divided into sub-questions. Answer all questions.
- Total time: 45 minutes.
- Total marks: 50.

Question 1: Latency and Bandwidth

#1 Calculate the effective bandwidth for sending a message from one node to another in the following situation:

	 Message size Speed of propagation Distance of copper cabling between nodes Raw bandwidth supported by the communication channel Sending overhead Receiving overhead 	1 024 bytes 200 Mm/s 200 m 50 Mbit/s 100 μs 100 μs	
	Hint: remember Effective bandwidth = Message size / total latency		[6]
	Question 2: Communication	l	[6 Total]
#1	Explain what is meant by a 'barrier' when referring to synchro	nisation.	[3]
#2	Describe the difference between 'broadcast' and 'scatter' con schemes.	nmunication	[3]
	Question 3: Cloud Computing	I	[7 Total]
#1	Briefly explain what is meant by 'platform as a service'.		[3]
#2	With regards to cloud computing, what is meant by 'virtualisa	tion'.	[4]

Question 4: Seminar Related Multiple Choice

[8 Total]

#1 Which of the following package types is a THT DIL (aka DIP) package? Select one of the letters for your answer below.[2]



- #2 In terms of chip testing based on running input tests on an n-input chip: the chip under test is considered fault-free if and only if which of one of the following conditions is met? (choose one answer only)
 [2]
 - a) It returns output true for any input given
 - b) All of its 2ⁿ input patterns are handled correctly
 - c) If the output changes after the input is changed
 - d) If there is an input sequence that causes the chip to stop responding to inputs
- #3 Answer 'ASIC' or 'FPGA' in response to each of the four statements below. Indicate whether an ASIC or an FPGA is relevant to the situation mentioned.
 [4]
 - 1. This technology is reprogrammable
 - 2. This technology is the faster of the two
 - 3. This technology wastes very little space
 - 4. This technology is more common for low-volume production

	Question 5: GPGPU	[7 Total]
#1	Describe, with diagrams, the OpenCL memory model.	[5]
#2	By means of an example, explain the get_global_id() function and how (from the kernel's point of view).	to use it [2]
	Question 6: FPGA and ASIC [16 Total]
#1	What is meant by a 'cell' when referring to ASICs?	[2]
#2	Draw a diagram of a typical FPGA logic unit. Hint: it's only 4 marks, so draw a simplified v	version [4]
#3	By referring to your diagram above, explain how a logic unit can be config an and gate.	ured into [2]
#4	Describe, with diagrams, a typical FPGA architecture. How are the lo interconnected? How are these connections made reconfigurable?	ogic units [6]
#5	Modern FPGAs have more than just reconfigurable logic units. Give two e of these 'extra' features.	examples [2]